Reviews and Advances in Internet of Things Technologies

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Deadline for manuscript submissions:
closed (15 November 2021)

Message from the Guest Editors

Dear Colleagues

The Internet of Things is made of devices and objects, e.g. sensors, wearables, smartphones, that are connected together through the internet. The connected devices can be combined with automated systems and artificial intelligence to perform actions or to learn specific data patterns.

IoT technologies will revolutionise our life in the years to come. From smart objects to connected machines in factories that have the potential to enable the Industry 4.0 revolution.

This Special Issue will bring together review papers on the recent advances in the multidisciplinary field of IoT technologies and the important gaps that still remain in order to obtain massive diffusion. Articles in this Special Issue will address topics that include communication, networking, sensing, materials, integration and data science. The Special Issue is edited by the board members of the *ICT* section of *Technologies*:

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Special Issue

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Message from the Editor-in-Chief

Technologies, provides a single focus for reporting on developments of all technologies, regardless of their application. It is our intention that *Technologies* becomes the journal of choice for both researchers wanting to publish their work and technologists wishing to exploit the high quality research across a wide range of potential applications. Through its open access policy, its quick publication cycle, *Technologies* will facilitate the rapid uptake and development of the research presented, ultimately providing benefit to the wider society.

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